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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN THE MATTER OF THE NEW PCT NATIONAL PHASE PATENT APPLICATION

OF: Makoto OTSUKI et al.

USSN: NEW - TO BE ASSIGNED

FILED: June 3, 2005

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FOR: Method of Manufacturing Single-Crystal  
Semiconductor Wafers and Laser  
Machining Apparatus Therefor

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PRELIMINARY AMENDMENT

Dear Sir:

Please amend the above identified patent application as follows.

[AMENDMENT FOLLOWS ON NEXT PAGE]